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PENDING CLAIMS

The following is a list of currently pending claims. No claims are added, cancelled, or amended in this response.

1. (Original) A thin film transistor comprising polysilicon, wherein the polysilicon is formed by a method comprising:

depositing a first layer of amorphous silicon;

depositing silicon nuclei on the first layer of amorphous silicon;

depositing a second layer of amorphous silicon over the first layer and the nuclei, wherein conversion of the first layer to hemispherical grains before deposition of the second layer is substantially prevented; and

annealing the first and second layers of amorphous silicon to induce crystallization.

- 2. (Original) The thin film transistor of claim 1, further comprising a charge storage region.
- 3. (Original) The thin film transistor of claim 2, wherein the charge storage region is ONO-type.
- 4. (Original) The thin film transistor of claim 2, wherein the charge storage region comprises a floating gate.
- 5. (Original) A monolithic three dimensional memory array comprising memory cells, said memory cells comprising polysilicon, any of said polysilicon crystallized by a method comprising:

embedding deposited silicon nuclei between layers of amorphous silicon; and crystallizing from the embedded silicon nuclei.

6. (Original) The monolithic three dimensional memory array of claim 5, wherein the memory cells comprise TFTs.

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- 7. (Original) The monolithic three dimensional memory array of claim 5, where the memory cells comprise antifuses and either diodes or diode components.
- 8. (Original) A thin film transistor comprising a channel region formed by a method comprising:
 - embedding deposited silicon nuclei between layers of amorphous silicon; and annealing the nuclei and amorphous silicon layers.
- 9. (Original) The thin film transistor of claim 8, further comprising a charge storage region.
- (Original) The thin film transistor of claim 9, wherein the charge storage region is ONO-type.
- 11. (Original) The thin film transistor of claim 9, wherein the charge storage region comprises a floating gate.